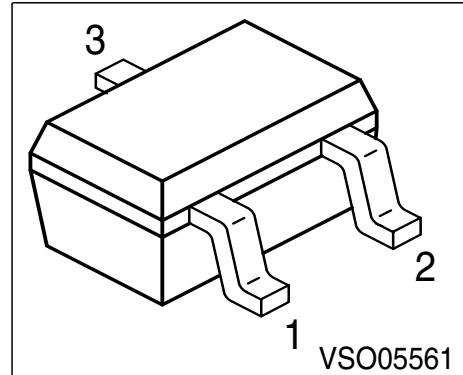
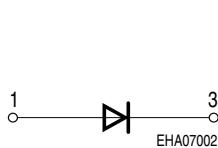


## Silicon Schottky Diodes

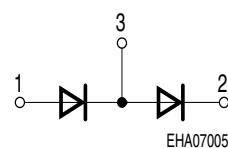
- For low-loss, fast-recovery, meter protection, bias isolation and clamping applications
- Integrated diffused guard ring
- Low forward voltage



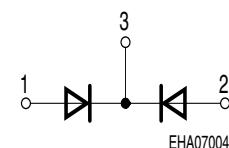
**BAS 125W**



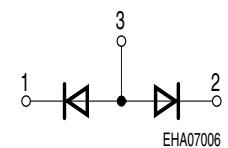
**BAS 125-04W**



**BAS 125-05W**



**BAS 125-06W**



**ESD:** Electrostatic discharge sensitive device, observe handling precaution!

Type	Marking	Pin Configuration			Package
BAS 125W	13s	1 = A	2 n.c.	3 = C	SOT-323
BAS 125-04W	14s	1 = A1	2 = C2	3 = C1/A2	SOT-323
BAS 125-05W	15s	1 = A1	2 = A2	3 = C1/2	SOT-323
BAS 125-06W	16s	1 = C1	2 = C2	3 = A1/2	SOT-323

## Maximum Ratings

Parameter	Symbol	Value	Unit
Diode reverse voltage	$V_R$	25	V
Forward current	$I_F$	100	mA
Surge forward current ( $t < 100\mu s$ )	$I_{FSM}$	500	
Total power dissipation BAS 125W, $T_S = 93\text{ }^\circ\text{C}$	$P_{tot}$	250	mW
BAS 125-04W, -05W, -06W , $T_S = 84\text{ }^\circ\text{C}$	$P_{tot}$	250	
Junction temperature	$T_j$	150	$^\circ\text{C}$
Operating temperature range	$T_{op}$	-55 ... 150	
Storage temperature	$T_{stg}$	-55 ... 150	

## Thermal Resistance

Junction - ambient <sup>1)</sup> BAS 125W	$R_{thJA}$	$\leq 310$	K/W
Junction - ambient <sup>1)</sup> BAS 125-04W ...	$R_{thJA}$	$\leq 425$	
Junction - soldering point BAS 125W	$R_{thJS}$	$\leq 230$	
Junction - soldering point BAS 125-04W ...	$R_{thJS}$	$\leq 265$	

1) Package mounted on epoxy pcb 40mm x 40mm x 1.5mm / 0.5cm<sup>2</sup> Cu

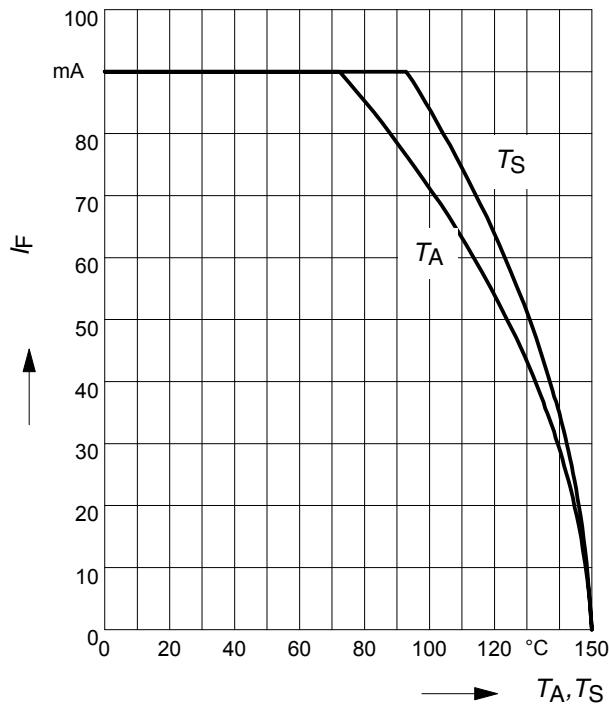
**Electrical Characteristics** at  $T_A = 25^\circ\text{C}$ , unless otherwise specified.

<b>Parameter</b>	<b>Symbol</b>	<b>Values</b>			<b>Unit</b>
		<b>min.</b>	<b>typ.</b>	<b>max.</b>	
<b>DC characteristics</b>					
Reverse current $V_R = 20 \text{ V}$ $V_R = 25 \text{ V}$	$I_R$	-	-	100 150	nA
Forward voltage $I_F = 1 \text{ mA}$ $I_F = 10 \text{ mA}$ $I_F = 35 \text{ mA}$	$V_F$	- - -	385 530 800	400 650 950	mV
<b>AC characteristics</b>					
Diode capacitance $V_R = 0 \text{ V}, f = 1 \text{ MHz}$	$C_T$	-	-	1.1	pF
Differential forward resistance $I_F = 5 \text{ mA}, f = 10 \text{ kHz}$	$R_f$	-	16	-	$\Omega$

**Forward current  $I_F = f(T_A^*; T_S)$**

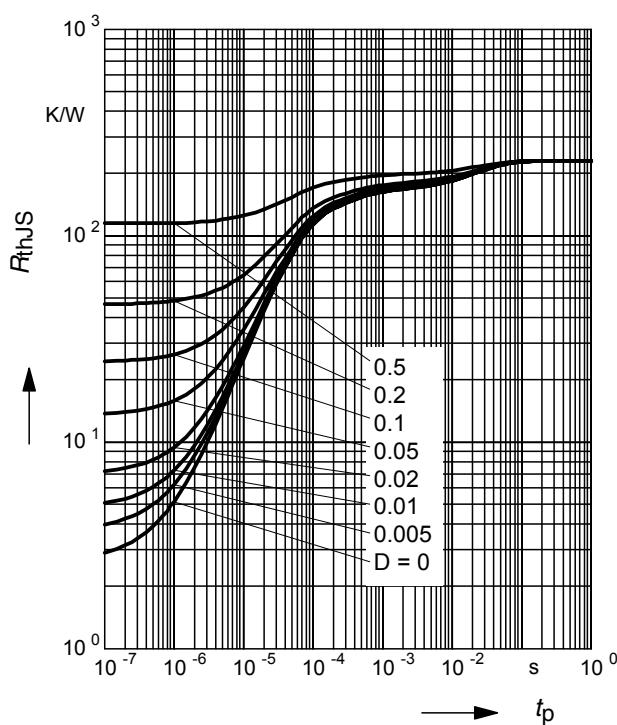
\* Package mounted on epoxy

BAS 125W



**Permissible Pulse Load  $R_{thJS} = f(t_p)$**

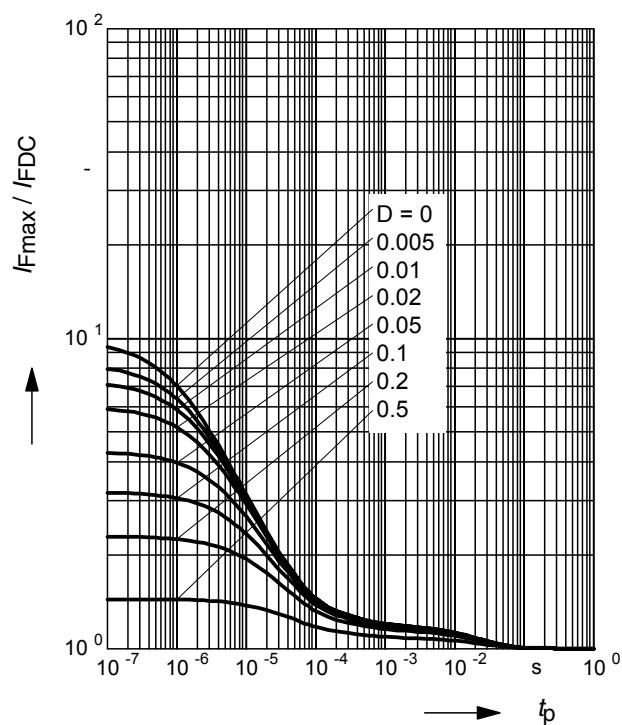
BAS 125W



**Permissible Pulse Load**

$I_{Fmax} / I_{FDC} = f(t_p)$

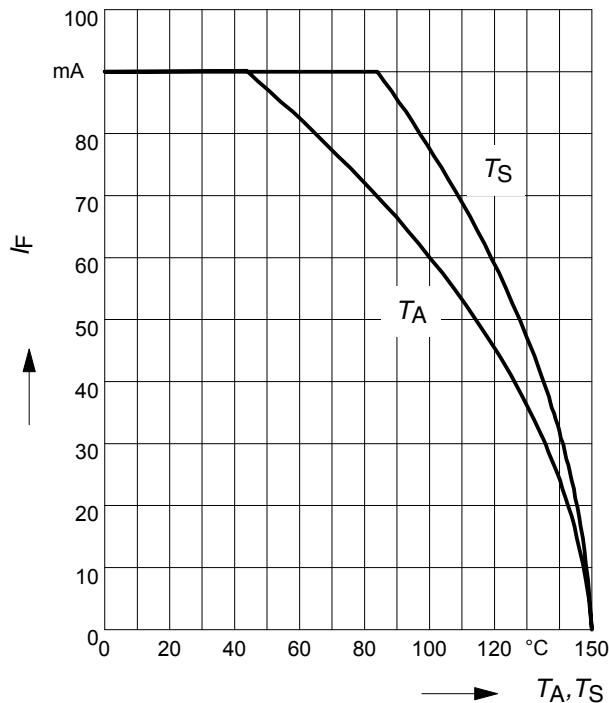
BAS 125W



**Forward current  $I_F = f(T_A^*; T_S)$**

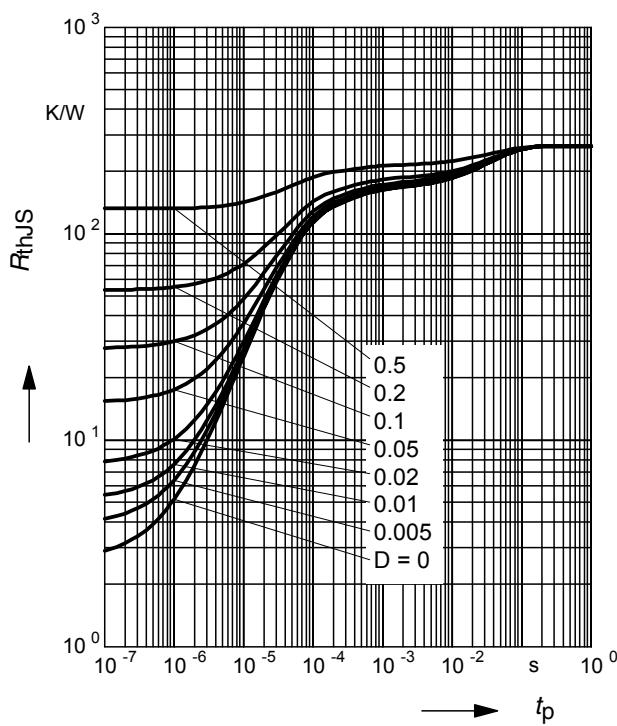
\* Package mounted on epoxy

BAS 125-04W ... ( $I_F$  per diode)



**Permissible Pulse Load  $R_{thJS} = f(t_p)$**

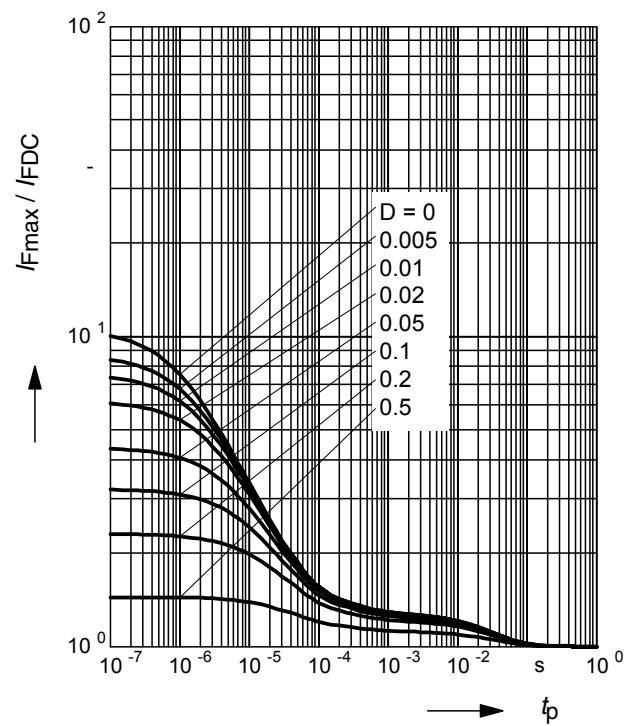
BAS 125-04W ...



**Permissible Pulse Load**

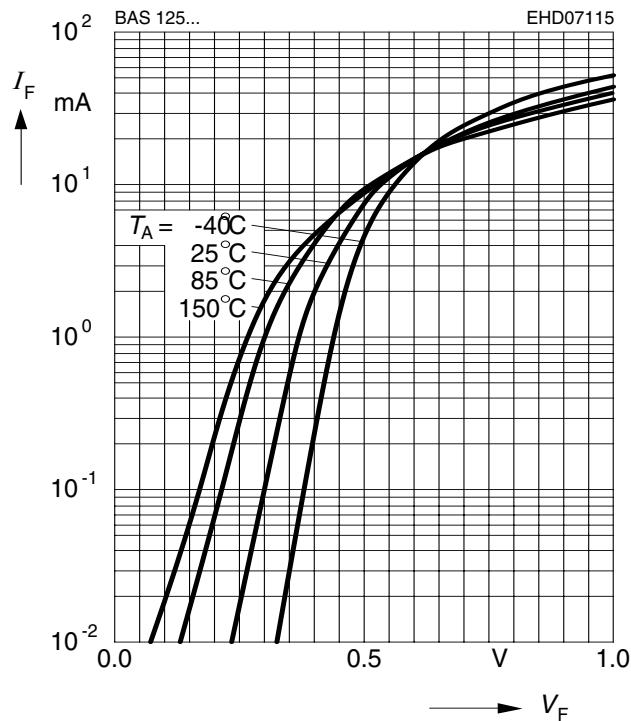
$I_{Fmax} / I_{FDC} = f(t_p)$

BAS 125-04W ...



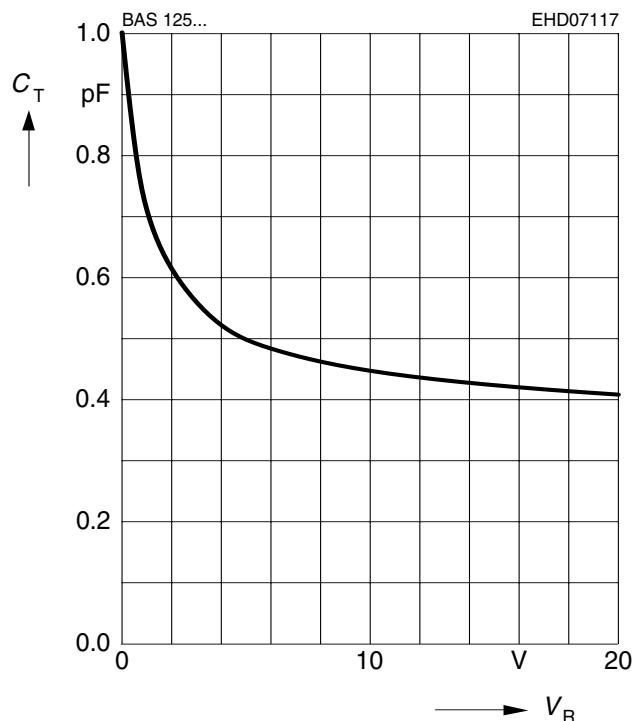
**Forward current  $I_F = f(V_F)$**

$T_A$  = Parameter



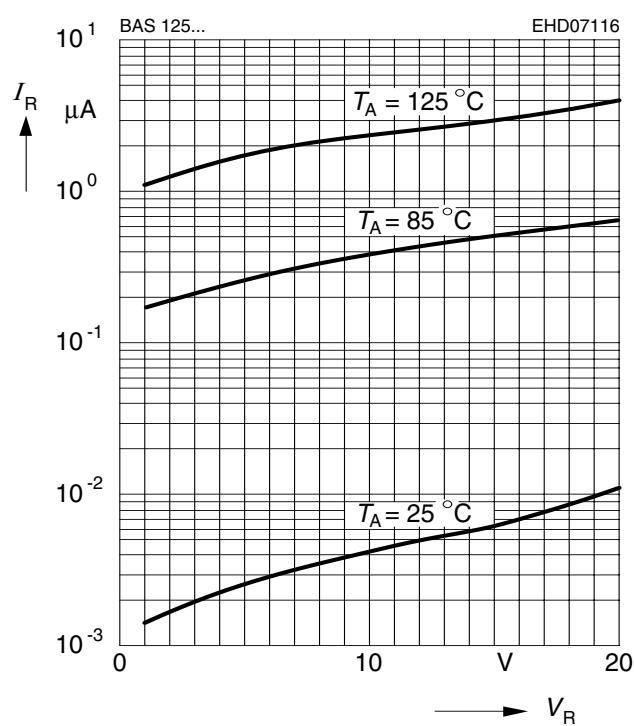
**Diode capacitance  $C_T = f(V_R)$**

$f = 1\text{MHz}$



**Reverse current  $I_R = f(V_R)$**

$T_A$  = Parameter



**Differential forward resistance  $r_f = f(I_F)$**

$f = 10\text{ kHz}$

